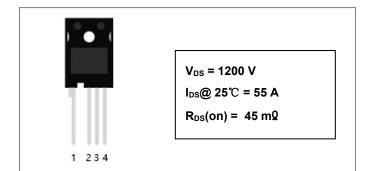
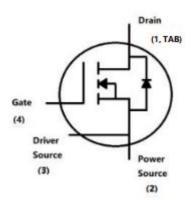


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# S2M0040120K-1 1200V SIC POWER MOSFET



### **Circuit Diagram**



#### Description

S2M0040120K-1 is single SiC Power MOSFET packaged in TO-247-4 case. The device is a high voltage n-channel Enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S2M0040120K-1 is ideal for energy sensitive, high frequency applications in challenging environments.

#### Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) =  $45m\Omega$  .
- Fast switching speed and low switching losses.
- Very fast and robust intrinsic body diode.
- Process of non-bright Tin electroplatin
- "-A" is an AEC-Q101 qualified device

### Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS

### Maximum Ratings(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Drain Source Voltage	V <sub>DSS</sub>	$V_{GS} = 0V$ , $I_{DS} = 100uA$ , $T_j = 25^{\circ}C$	1200	V
Gate Source Voltage	V <sub>GSS</sub>	T <sub>j</sub> = 25°C, Absolute maximum values, AC (f>1Hz)	-10 to 25	V
Gate Source Voltage	V <sub>GSOP</sub>	T <sub>j</sub> = 25°C Recommended Operational Values	-5 to 20	V
Continuous Drain Current	ID	$V_{GS} = 20V, T_j = 25^{\circ}C$	55	A
	ID	$V_{GS} = 20V, T_j = 100^{\circ}C$	39	А
Pulsed Drain Current	I <sub>D,pulse</sub>	Pulse width tP limited by Tjmax	160	А
Power Dissipation	PD	TC=25°C, Tj = 175 °C	348	W
Solder Temperature	TL	1.6mm (0.063") from case for 10s	260	°C

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### Electrical Characteristics(T=25℃ unless otherwise specified)

Characteristics	Symbol	Condition	Mi n.	Тур.	Max.	Units
Drain Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 100uA	1200			V
	Maaaa	$V_{DS} = V_{GS}$ , $I_D = 10 \text{mA}$	1.8	2.4	4	V
Gate Threshold Voltage	$V_{GS(th)}$	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 10mA T <sub>J</sub> = 175 °C		1.55		V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 1200V, V <sub>GS</sub> = 0V		1	100	uA
Gate Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = 20V, V <sub>DS</sub> = 0V			250	nA
Duraine Courses On Chata Desistance	D	V <sub>GS</sub> = 20V, I <sub>D</sub> = 40A		45	52	mΩ
Drain Source On-State Resistance	$R_{\text{DS(on)}}$	V <sub>GS</sub> = 20V, I <sub>D</sub> = 40A, T <sub>J</sub> = 175 °C		73		mΩ
Transcenductores	afa	V <sub>DS</sub> = 20 V, I <sub>DS</sub> = 40 A		10		S
Transconductance	gfs	V <sub>DS</sub> = 20 V, I <sub>DS</sub> = 40 A, T <sub>J</sub> = 175 °C		12		S
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0V,		1904		
Output Capacitance	Coss	V <sub>DS</sub> = 1000V		108		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>	V <sub>AC</sub> = 25mV f = 1MHz		6		
Coss Stored Energy	Eoss			72.9		uJ
Turn-On Switching Energy	Eon	V <sub>DS</sub> = 800V, V <sub>GS</sub> = -5/20V		0.25		
Turn-Off Switching Energy	E <sub>OFF</sub>	I <sub>D</sub> =40A, R <sub>G(ext)</sub> =2.5Ω, L=99uH		0.05		mJ
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DS</sub> = 800V, V <sub>GS</sub> = -5/20V		12		
Rise Time	tr	I <sub>D</sub> = 40A, R <sub>G(ext)</sub> =2.5Ω		14		
Turn-Off Delay Time	$t_{d(off)}$	Inductive Load Timing relative to VDS Per IEC60747-8-4 pg 83		22		ns
Fall Time	t <sub>f</sub>	• • • • • • • • • • • • • • • • • • •		4		
Internal Gate Resistance	R <sub>G(int)</sub>	f = 1MHz, VAC = 25 mV		2.6		Ω
Gate to Source Charge	$Q_{gs}$	V <sub>DS</sub> = 800V, V <sub>GS</sub> = -5/20V, I <sub>D</sub> = 40A		34.3		
Gate to Drain Charge	$Q_{gd}$	Per IEC60747-8-4 pg 21		32.1		nC
Total Gate Charge	Qg			92.1		

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### **Reverse Diode Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Diode Forward Voltage	Ma	V <sub>GS</sub> = -5V, I <sub>SD</sub> = 20A	3.6		V
	V <sub>SD</sub>	V <sub>GS</sub> = -5V, I <sub>SD</sub> = 20A, T <sub>J</sub> =175°C	3.2		V
Continuous Diode Forward Current	ls	Tc=25℃	44		А
Reverse Recovery Time	t <sub>rr</sub>	V <sub>GS</sub> =-5V, I <sub>SD</sub> =50A, T <sub>J</sub> =25°C	43.4		ns
Reverse Recovery Charge	Qrr	V <sub>R</sub> =800V	162		nC
Peak Reverse Recovery Current Imm		dif/dt=1047A/µs	8.1		А

### **Thermal-Mechanical Specifications:**

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	Rejc	DC operation	0.43	°C/W
Maximun Thermal Resistance Junction to Ambient	$R_{ heta JA}$		32.6	°C/W

## Ordering Information:

Device	Package	Shipping
S2M0040120K-1	TO-247-4	30pcs/tube

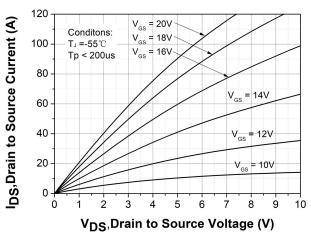
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#### **Ratings and Characteristics Curves**



#### Figure 1. Output Characteristics T<sub>J</sub> = -55 °C

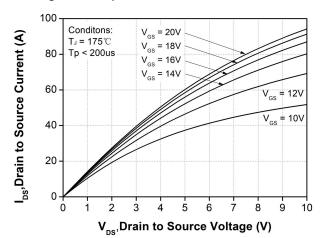


Figure 3. Output Characteristics T<sub>J</sub> = 175°C

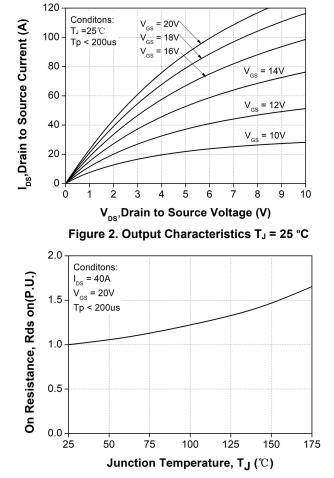
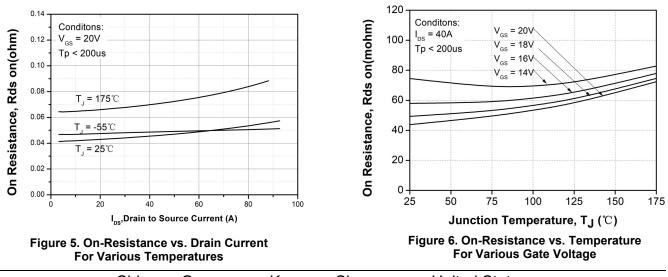


Figure 4. Normalized On-Resistance vs. Temperature



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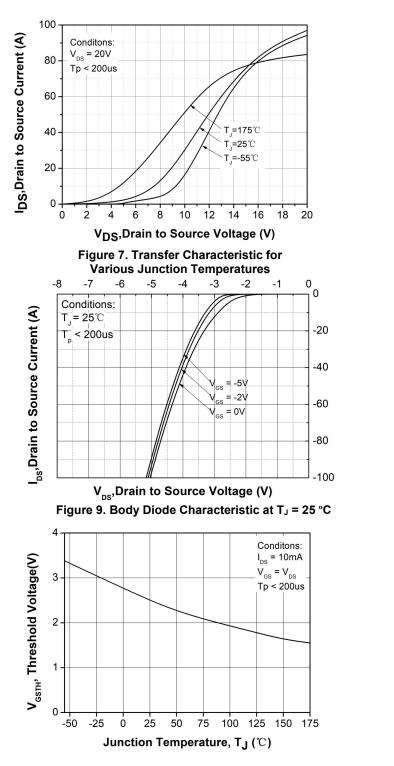
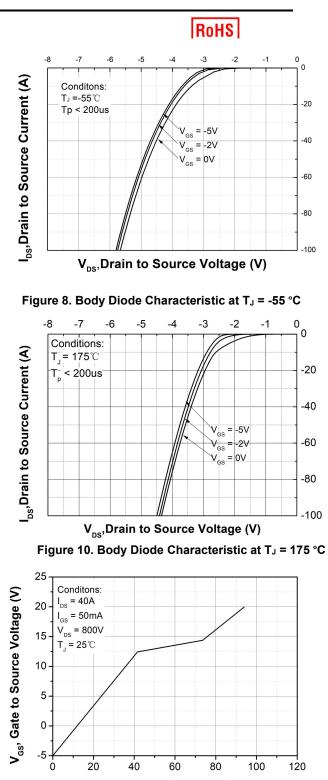


Figure 11. Threshold Voltage vs. Temperature

### S2M0040120K-1



Q<sub>g</sub>, Gate Charge (nC)

Figure 12. Gate Charge Characteristic

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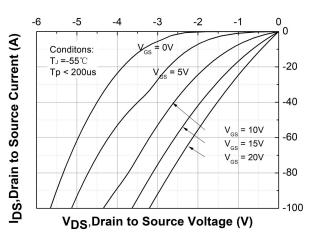


Figure 13. 3rd Quadrant Characteristic at  $T_J$  = -55 °C

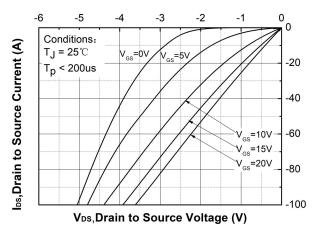
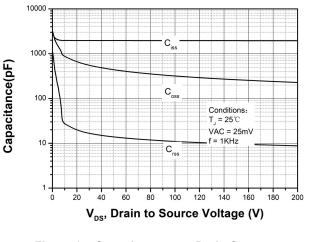
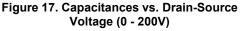


Figure 15. 3rd Quadrant Characteristic at T<sub>J</sub> = 175°C







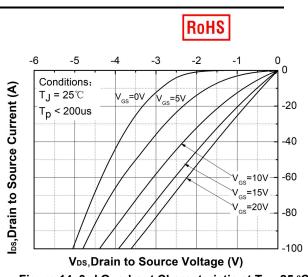


Figure 14. 3rd Quadrant Characteristic at  $T_J$  = 25 °C

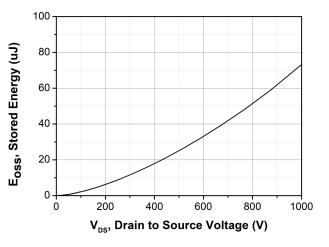
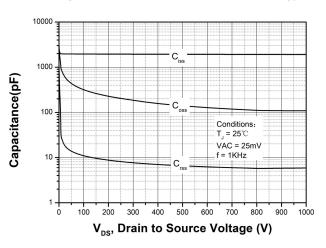
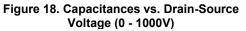


Figure 16. Output Capacitor Stored Energy

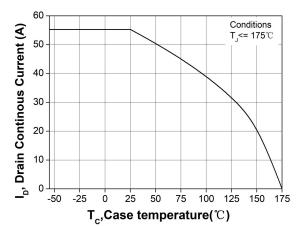




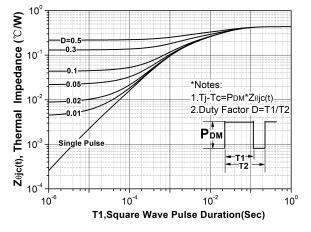
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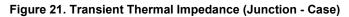


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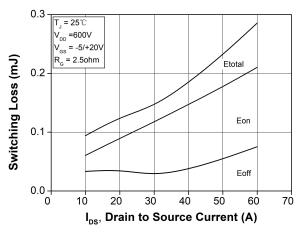


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V<sub>DD</sub> = 600V)

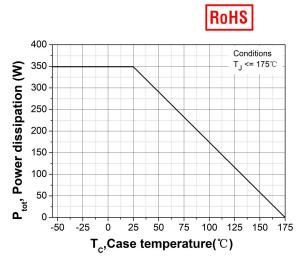


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

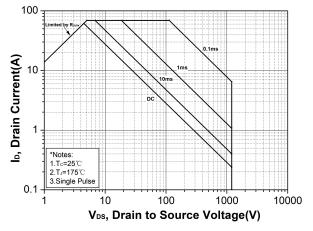
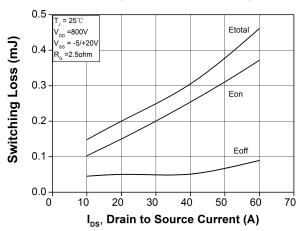
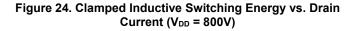


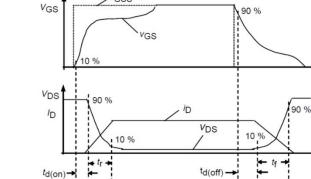
Figure 22. Safe Operating Area



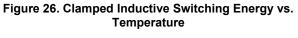


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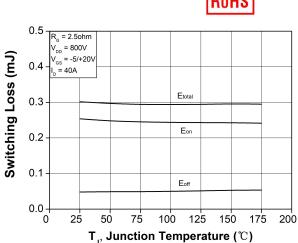
Figure 28. Switching Times Definition



VGSS



lot



S2M0040120K-1

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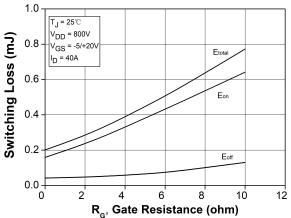


Figure 25. Clamped Inductive Switching Energy vs. R<sub>G(ext)</sub>

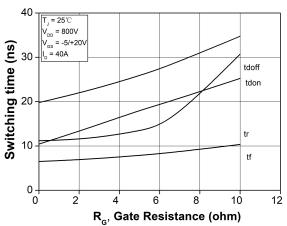
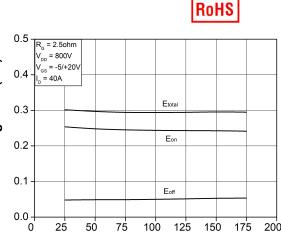


Figure 27. Switching Times vs. R<sub>G(ext)</sub>



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### **Marking Diagram**

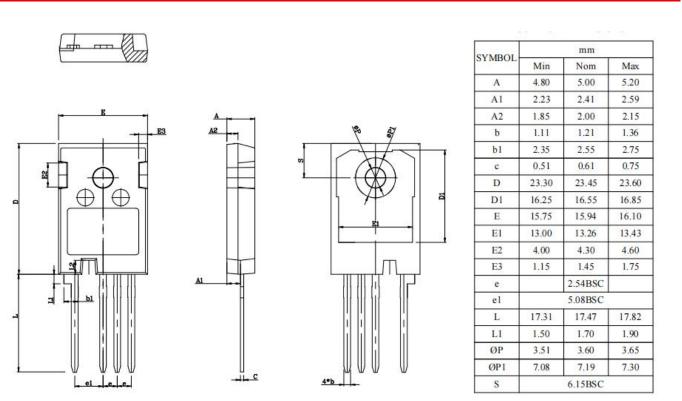


#### Where XXXXX is YYWWL

S2M	= Device Type
0040	= $R_{DS}(on)$
120	= Reverse Voltage (1200V)
K	= Package
SSG	= SSG
YY	= Year
WW	= Week
L	= Lot Number
<b>•</b> • • •	

Cautions: Molding resin Epoxy resin UL:94V-0

### Mechanical Dimensions TO-247-4





### S2M0040120K-1



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